

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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## **Powering Communications and Technology**



## **FEATURES**

- 20W Standard Package
- 100°C Case Operation
- 3.3V Output Available
- Open Frame or Encapsulated
- 88% Efficiency at 5V
- · Wide Range Input
- 1500V Isolation
- Short Circuit Protection

### **TECHNICAL SPECIFICATIONS**

Input	
Voltage Range	
24 VDC Nominal	16 - 36 VDC
48 VDC Nominal	36 - 72 VDC
Input Undervoltage Lockout	<34V or <17V
UVLO Hysteresis	1V Nom.
Reflected Ripple Input Reverse Voltage Protection	25 mA Shunt Diode

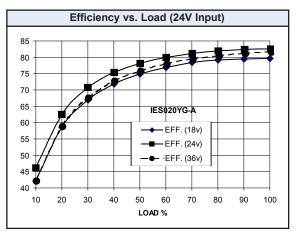
Outp	out
Setpoint Accuracy	±1%
Line Regulation V <sub>in</sub> Min V <sub>in</sub> Max., I <sub>ou</sub>	<sub>t</sub> Rated 0.2% V <sub>out</sub>
Load Regulation I <sub>out</sub> Min I <sub>out</sub> Max., V	in Nom. 0.5% V <sub>out</sub>
Minimum Output Current	10 %
Dynamic Regulation, Loadstep	25% l <sub>out</sub>
Pk Deviation	4% V <sub>out</sub>
Settling Time	500 μs
Voltage Trim Range	±10%
Short Circuit / Overcurrent Protection	Shutdown / Hiccup
Current Limit Threshold Range, % of In	ut Rated 110 - 140%
OVP Trip Range	115 - 140% V <sub>out</sub> Nom.
OVP Type	Second Control Loop, Self-Recovering

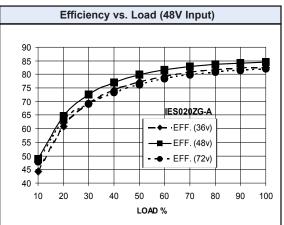
General				
Turn-On Time	10 ms			
Remote Shutdown	Positive Logic			
Switching Frequency	300 kHz Open Frame / 450 kHz Cased			
Isolation				
Input - Output	1500 VDC			
Input - Case (24 Vin Units)	500 VDC			
Output - Case (48 <sub>Vin</sub> Units)	500 VDC			
Temperature Coefficient	0.03%/°C			
Case Temperature				
Operating Range	-40 To +100°C			
Storage Range	-40 To +125°C			
Humidity Max., Non-Condensing	95%			
Vibration, 3 Axes, 5 Min Each	5 g, 10 - 55 Hz			
MTBF <sup>†</sup> (Bellcore TR-NWT-000332)	1.9 x 10 <sup>6</sup> hrs			
Safety	UL, CSA, EN60950			
Weight (approx.)	1.2 oz			

# IES SERIES 20 WATT

#### **DESCRIPTION**

IES DC/DC converters provide up to 20 Watts of output power in an industry standard package. With 88% efficiency and a maximum case temperature of 100°C, the IES is well suited for the most demanding telecom, networking, and industrial applications. The IES features 1500 VDC isolation, short circuit, and overtemperature protection.





#### Notes

† MTBF predictions may vary slightly from model to model.

Specifications typically at 25  $^{\circ}\text{C},$  normal line, and full load, unless otherwise stated.

Soldering Conditions: I/O pins, 260°C, ten seconds; fully compatible with commercial wave-soldering equipment.

Safety: Agency approvals may vary from model to model. Please consult factory for specific model information.

Units are water-washable and fully compatible with commercial spray or immersion post wave-solder washing equipment.



# IES SERIES 20 WATT

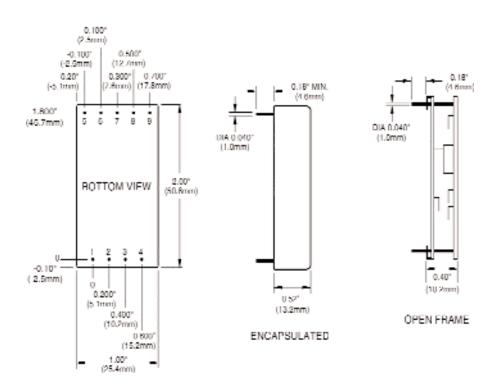
# **Powering Communications and Technology**

**MODELS** - (See the last page of Section for options.)

Selection Chart							
Model	Vin	Vin Range	lin Max.*	Vout	lout Rated	Ripple & Noise	Efficiency
	(Volts)	(Volts)	(Amps)	(Volts)	(Amps)	Pk-Pk (mV)	Typ. **
IES020YG-A	24	16 - 36	1.23	5.0	4.0	75	87%
IES013ZE-A	48	36 - 72	0.45	3.3	4.0	150	83%
IES020ZG-A	48	36 - 72	0.65	5.0	4.0	75	87%

<sup>\*</sup> Maximum input current at minimum input voltage, maximum rated output power.

## **MECHANICAL DRAWING**



Thermal Impedance				
Natural Convection 100 LFM 200 LFM 300 LFM 400 LFM	Encapsulated Modules 15.4 °C/W 12.2 °C/W 9.3 °C/W 7.4 °C/W 6.4 °C/W	Open Frame Modules 14.9 °C/W 11.3 °C/W 8.3 °C/W 6.8 °C/W 5.4 °C/W		
Note: Thermal impedance data is dependent on many environmental factors. The exact thermal performance should be validated for specific application.				

Pin	Function		
1	+V <sub>in</sub>		
2	-V <sub>in</sub>		
3	No Pin		
4	Shutdown		
5	+V <sub>out</sub>		
6	+V <sub>out</sub> -V <sub>out</sub>		
7	Trim		
8	No Pin		
9	No Pin		

Tolerances		
Inches: .XX ± 0.020 .XXX ± 0.010	(Millimeters) .X $\pm$ 0.5 .XX $\pm$ 0.25	
Pin: ± 0.002	± 0.05	
Case: + 0.04, - 0.00	+ 1.0, - 0.00	
(Dimensions as listed unless otherwise specified.)		

<sup>\*\*</sup> At nominal Vin, rated output.



# **OPTIONS**

## **Powering Communications and Technology**

When ordering equipment options, use the following suffix information. Select the option(s) that you prefer and add them to the model number. Example ordering options are located below the options table.

OPTIONS	SUFFIX	APPLICABLE SERIES	REMARKS
Negative Logic	N	HAS, HBD, HBS, HES, HLS, LES,	TTL "Low" Turns Module ON
		QBS, QES, QLS, TES, TQD	TTL "High" Turns Module OFF
		HAS, HBD, HBS, HES, HLS, QBS, QES,	
Lucent Compatible Trim	Т	QLS	
Terminal Strip	TS	XWS, XWD, XWT	
Trim	1	IAS, LES	
Enable	2	IAD, IAS, LES, SMS	
Trim and Enable	3	IAS, LES	
Current Share	4	SMS	
Headerless	Υ	Encapsulated EWS, IWS, OWS	
PIN LENGTH AND HEATSINK OPTIONS			Standard Pin Length is 0.180" (4.6mm)
0.110" (2.8mm) Pin Length	8	All Units (Except SMS)	
0.150" (3.8mm) Pin Length	9	All Units (Except SMS)	
0.24" (6.1mm) Horizontal Heatsink	1H	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad
0.24" (6.1mm) Vertical Heatsink	1V	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad
0.45" (11.4mm) Horizontal Heatsink	2H	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad
0.45" (11.4mm) Vertical Heatsink	2V	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad
0.95" (24.1mm) Horizontal Heatsink	3H	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad
0.95" (24.1mm) Vertical Heatsink	3V	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad

#### **Example Options:**

HBS050ZG-ANT3V = HBS050ZG-A with negative logic, Lucent compatible trim, and 0.95" vertical heatsink. LES015YJ-3N = LES015YJ with optional trim and enable, negative logic.

QBS066ZG-AT8 = QBS066ZG-A with Lucent compatible trim and 0.110" pin length.

NUCLEAR AND MEDICAL APPLICATIONS - Power-One products are not authorized for use as critical components in life support systems, equipment used in hazardous environments, or nuclear control systems without the express written consent of the President of Power-One, Inc.

TECHNICAL REVISIONS - The appearance of products, including safety agency certifications pictured on labels, may change depending on the date manufactured. Specifications are subject to change without notice.